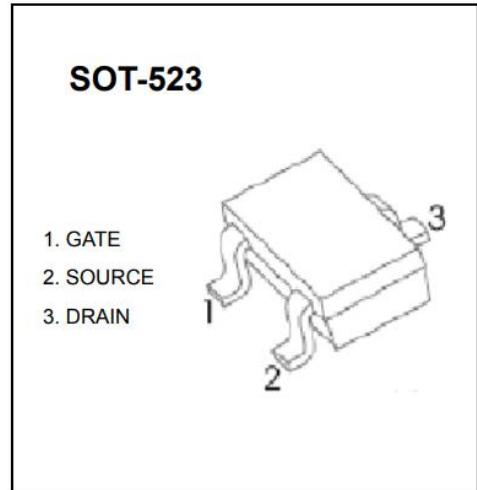


## Plastic-Encapsulate MOSFETs

N-Channel MOSFET

<b>V<sub>(BR)DSS</sub></b>	<b>R<sub>DS(on)MAX</sub></b>	<b>I<sub>D</sub></b>
20V	380 mΩ@4.5V	0.75A
	450 mΩ@2.5V	
	800 mΩ@1.8V	



### FEATURE

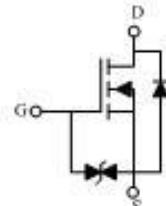
- High-Side Switching
- Low On-Resistance
- Low Threshold
- Fast Switching Speed

**MARKING:**34K

### APPLICATION

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories
- Battery Operated Systems
- Power Supply Converter Circuits
- Load/Power Switching Cell Phones, Pagers

### Equivalent Circuit



**Maximum ratings (T<sub>a</sub>=25°C unless otherwise noted)**

Parameter	Symbol	Value	Unit
Drain-Source voltage	V <sub>DSS</sub>	20	V
Typical Gate-Source Voltage	V <sub>GS</sub>	±12	
Drain Current-Continuous	I <sub>D</sub>	0.75	A
Drain Current -Pulsed(note1)	I <sub>DM</sub>	1.5	
Power Dissipation (note 2)	P <sub>D</sub>	200	mW
Thermal Resistance from Junction to Ambient	R <sub>θJA</sub>	625	°C/W
Storage Temperature	T <sub>j</sub>	150	°C
Junction Temperature	T <sub>stg</sub>	-55 ~+150	

## MOSFET ELECTRICAL CHARACTERISTICS

T<sub>a</sub>=25 °C unless otherwise specified

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
<b>On/Off States</b>						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA	20			V
Gate-Threshold Voltage(note 3)	V <sub>G(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	0.35		1.1	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>DS</sub> = 0V, V <sub>GS</sub> = ±10V			±20	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V			1	μA
Drain-Source On-State Resistance(note 3)	R <sub>D(on)</sub>	V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 650mA			380	mΩ
		V <sub>GS</sub> = 2.5V, I <sub>D</sub> = 550mA			450	
		V <sub>GS</sub> = 1.8V, I <sub>D</sub> = 450mA			800	
Forward Transconductance	g <sub>Fs</sub>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 800mA	1			s

### Switching Times (note 4)

Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>DD</sub> =10V, I <sub>D</sub> =500mA, V <sub>GS</sub> =4.5V, R <sub>G</sub> =10Ω		6.7		ns
Rise Time	t <sub>r</sub>			4.8		
Turn-Off Delay Time	t <sub>d(off)</sub>			17.3		
Fall Time	t <sub>f</sub>			7.4		

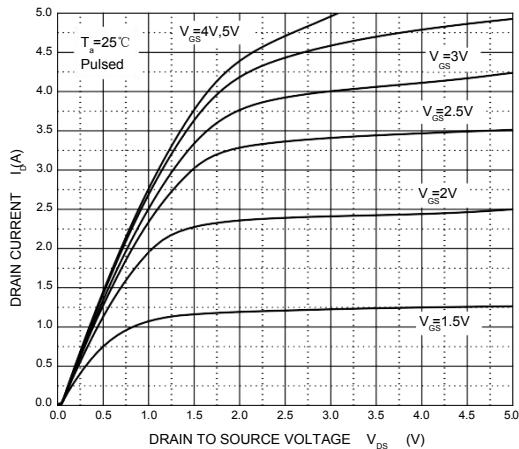
### Drain-Source Diode Characteristics

Drain-Source Diode Forward Voltage (note 3)	V <sub>SD</sub>	I <sub>S</sub> =0.15A, V <sub>GS</sub> = 0V			1.2	V
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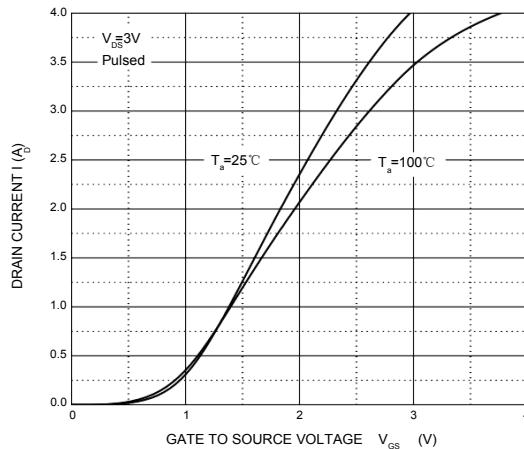
### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. This test is performed with no heat sink at T<sub>a</sub>=25°C.
3. Pulse Test : Pulse Width≤300μs, Duty Cycle≤0.5%.
4. These parameters have no way to verify.

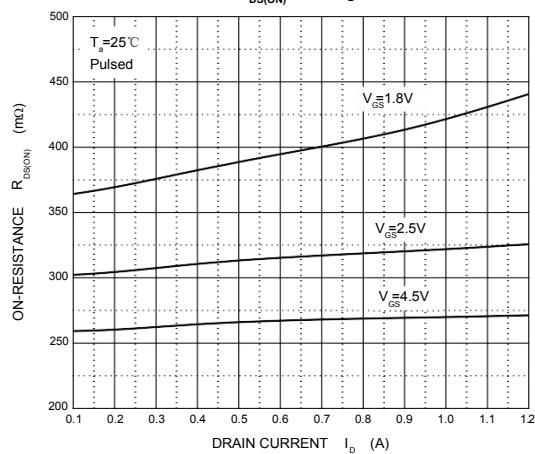
### Output Characteristics



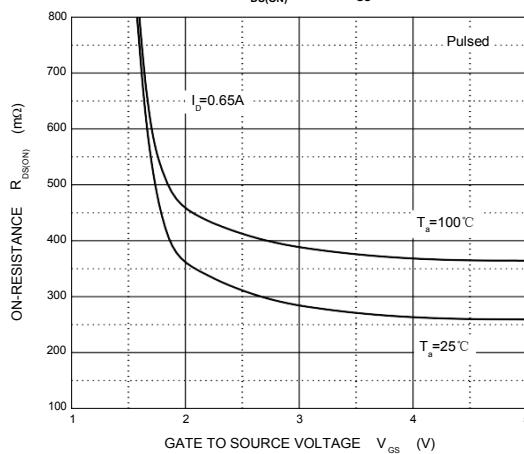
### Transfer Characteristics



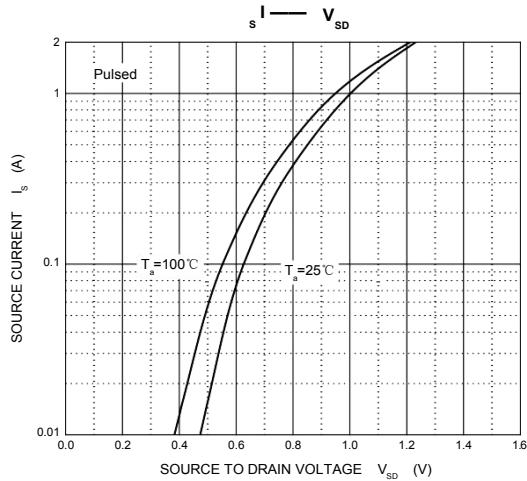
### $R_{DS(ON)}$ — $I_D$



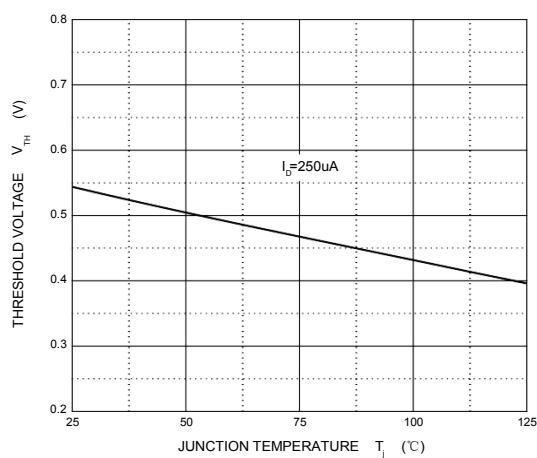
### $R_{DS(ON)}$ — $V_{GS}$



### $I_s$ — $V_{SD}$



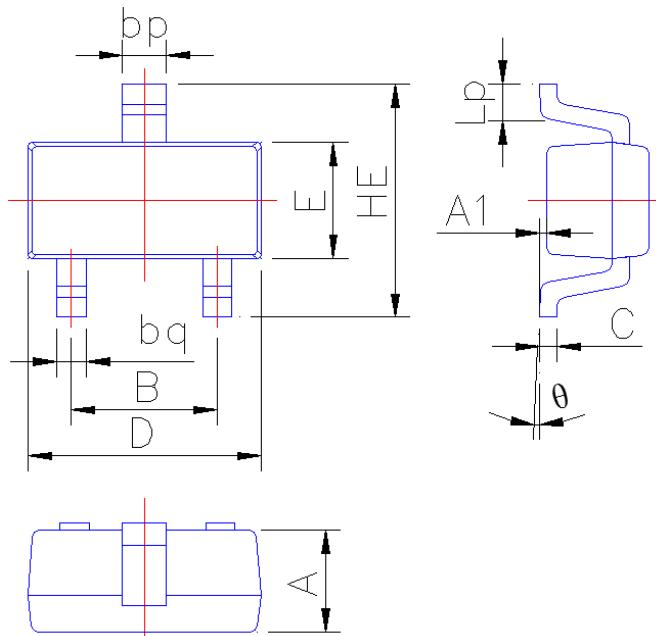
### Threshold Voltage



## PACKAGE OUTLINE

Plastic surface mounted package; 3 leads

**SOT-523**



Symbol	Dimension in Millimeters	
	Min	Max
A	0.60	0.80
A1	0.010	0.100
B	0.95	1.05
bp	0.26	0.40
bq	0.16	0.30
C	0.09	0.15
D	1.50	1.70
E	0.70	0.85
HE	1.45	1.75
Lp	0.16	0.36
θ	0°	5°